

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3849449

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YANG ZHAO	04/26/2016
PIU FRANCIS MAN	04/27/2016
LEYUE JIANG	04/27/2016
H Aidong LIU	04/27/2016
BIN LI	04/25/2016
RECEIVING PARTY DATA	
Name:	MEMSIC SEMICONDUCTOR (WUXI) CO., LTD.
Street Address:	NO. 2 XINHUIHUAN ROAD
Internal Address:	NEW DISTRICT
City:	WUXI
State/Country:	CHINA
Postal Code:	214028
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15140452
CORRESPONDENCE DATA	
Fax Number:	(206)792-5742
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	949-383-5384
Email:	pto@haniplaw.com
Correspondent Name:	HAN IP CORPORATION
Address Line 1:	4790 IRVINE BOULEVARD SUITE 105-347
Address Line 4:	IRVINE, CALIFORNIA 92620
ATTORNEY DOCKET NUMBER:	SNIP.0017US
NAME OF SUBMITTER:	ANDY M. HAN
SIGNATURE:	/Andy M. Han, Reg. No, 60266/
DATE SIGNED:	04/27/2016
This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 4

source=SNIP_0017US_Combined_Declaration_Assignment#page1.tif

source=SNIP_0017US_Combined_Declaration_Assignment#page2.tif

source=SNIP_0017US_Combined_Declaration_Assignment#page3.tif

source=SNIP_0017US_Combined_Declaration_Assignment#page4.tif

**COMBINED DECLARATION AND ASSIGNMENT FOR APPLICATION FOR UNITED STATES
LETTERS PATENT
DECLARATION**

Title of Invention: **METHOD FOR WAFER-LEVEL CHIP SCALE PACKAGE TESTING**

As the below named inventor, I hereby declare that:

- This declaration is directed to the attached U.S. patent application claiming the priority benefit of Chinese Patent Application No. 201510686666.1, filed on 21 October 2015 (2015/10/21).
- **The above-identified application was made or authorized to be made by me.**
- **I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.**
- **I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.**
- **I have reviewed and understand the contents of the present application, including the claims, as amended by any amendment specifically referred to herein.**
- **I acknowledge the duty to disclose to the Patent Office all information known to me to be material to patentability as defined in 37 C.F.R. § 1.56.**

POWER OF ATTORNEY

As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) associated with Customer No.

13859

to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

Send Correspondence to:

**Han IP Corporation
4790 Irvine Boulevard Suite 105-347
Irvine, CA 92620
Direct Telephone Calls To: (949) 383-5385
Email: pto@haniplaw.com**

ASSIGNMENT**PARTIES TO THE ASSIGNMENT**Assignor(s):

- | | |
|--------------------|----------------|
| 1. Yang Zhao | 4. Haidong Liu |
| 2. Piu Francis Man | 5. Bin Li |
| 3. Leyue Jiang | |

Assignee:

Memsic Semiconductor (Wuxi) Co., Ltd.
 No. 2 Xinhuihuan Road, New District
 Wuxi, Jiangsu 214028, China

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of the above-identified invention for which:

a provisional application for United States Letters Patent was filed on _____ and was given U.S. Serial No. _____ and/or

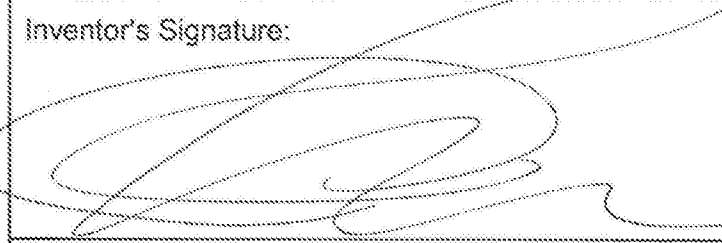
a non-provisional application for United States Letters Patent was/is:

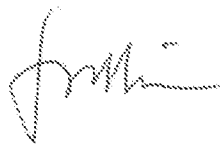
filed on _____ and was given U.S. Serial No. _____; or filed concurrently herewith.

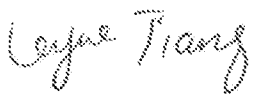
Assignors hereby authorize and request ASSIGNEE's legal representatives, of **Han IP Corporation, 4790 Irvine Boulevard Suite 105-347, Irvine, CA 92620**, who are associated with customer number **13859**, to handle all matters related to the above-identified application.

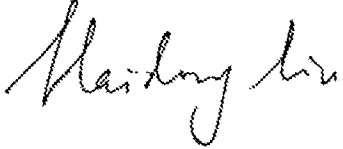
WHEREAS, Memsic Semiconductor (Wuxi) Co., Ltd. (hereinafter referred to as ASSIGNEE), a corporation of Suzhou, Jiangsu, China having a place of business at No. 2 Xinhuihuan Road, New District, Wuxi, Jiangsu 214028, China, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;


NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

Legal Name of First-Named Inventor: Yang ZHAO	
Inventor's Signature: 	Date: 4/26/2016
Residence: Andover, Massachusetts, U.S.A.	
Nationality: U.S.A.	
Mailing Address: One Tech Drive Suite 325, Andover, MA 01810, U.S.A.	

Legal Name of Co-Inventor: Piu Francis MAN	
Inventor's Signature: 	Date: 2016.4.27
Residence: Andover, Massachusetts, U.S.A.	
Nationality: Canada	
Mailing Address: One Tech Drive Suite 325, Andover, MA 01810, U.S.A.	

Legal Name of Co-Inventor: Leyue JIANG	
Inventor's Signature: 	Date: 2016.4.27
Residence: Suzhou, Jiangsu, China	
Nationality: China	
Mailing Address: No. 2 Xinhuihuan Road, New District, Wuxi, Jiangsu 214028 China	

Legal Name of Co-Inventor: Haidong LIU	
Inventor's Signature: 	Date: 4/27/2016
Residence: Suzhou, Jiangsu, China	
Nationality: China	
Mailing Address: No. 2 Xinhuihuan Road, New District, Wuxi, Jiangsu 214028 China	

Legal Name of Co-Inventor: Bin LI	
Inventor's Signature: 	Date: 04/25/2016
Residence: Andover, Massachusetts, U.S.A.	
Nationality: China	
Mailing Address: One Tech Drive Suite 325, Andover, MA 01810, U.S.A.	